SDLS005 - D2747, JUNE 1983 - REVISED MARCH 1988

- 8-Bit Serial-In, Parallel-Out Shift Registers with Storage
- Choice of Output Configurations:

'LS594 ... Buffered

'LS599 ... Open-Collector

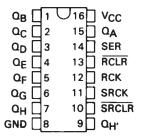
- Guaranteed Shift Frequency: DC to 20 MHz
- Independent Direct-Overriding Clears on Shift and Storage Registers
- Independent Clocks for Both Shift and Storage Registers

description

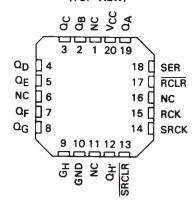
These devices each contain an 8-bit D-type storage register. The storage register has buffered ('LS594) or open-collector ('LS599) outputs. Separate clocks and direct-overriding clears are provided on both the shift and storage registers. A shift output (Q_H ') is provided for cascading purposes.

Both the shift register and the storage register clocks are positive-edge triggered. If the user wishes to connect both clocks together, the shift register will always be one clock pulse ahead of the storage register.

SN54LS594, SN54LS599 . . . J OR W PACKAGE SN74LS594, SN74LS599 . . . N PACKAGE (TOP VIEW)

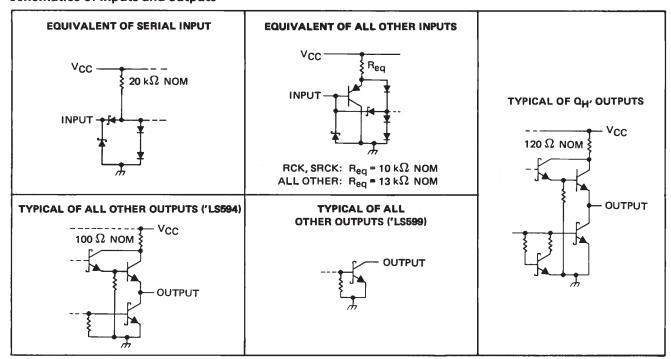


SN54LS594, SN54LS599 . . . FK PACKAGE (TOP VIEW)



NC — No internal connection

schematics of inputs and outputs



TEXAS INSTRUMENTS

SN54LS594, SN54LS599, SN74LS594, SN74LS599 8-BIT SHIFT REGISTERS WITH OUTPUT LATCHES

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS †		SN54LS'			SN74LS'				
				MIN	TYP#	MAX	MIN	TYP\$	MAX	UNIT	
VIK		V _{CC} = MIN,	I _I = 18 mA				– 1.5			- 1.5	٧
VOU 1	'LS594 Q	Voc - MIN	V _{IH} = 2 V,	I _{OH} = - 1 mA	2,4	3.2					V
		VIL = MAX		I _{OH} = 2.6 mA				2.4	3.1		
] VIL - WAA		I _{OH} = - 1 mA	2.4	3.2		2.4	3.2			
Іон	'LS599 Q	V _{CC} = MIN, V _{OH} = 5.5 V	V _{IH} = 2 V,	V _{1L} = MAX,			0.1			0.1	mA
V _{OL}	Q		V _{IH} = 2 V,	I _{OL} = 12 mA		0.25	0.4		0.25	0.4	V
		V _{CC} = MIN,		I _{OL} = 24 mA					0.35	0.5	
	Q _H ′	VIL = MAX		IOL = 8 mA		0.25	0.4		0.25	0.4	
				I _{OL} = 16 mA					0.35	0.5	
l ₁		V _{CC} = MAX,	V ₁ = 7 V				0.1			0.1	mA
ΉΗ		V _{CC} = MAX,	V ₁ = 2.7 V				20			20	μΑ
1	SER	V _{CC} = MAX,	V. = 0.4 V				- 0.4			- 0.4	mA
11L	All others	ACC - MAY	V - 0.4 V				- 0.2			- 0.2	IIIA
IOS§	'LS594 Q	V _{CC} = MAX,	V 0		- 30		– 130	- 30		- 130	mA
	QH'	ACC - MAY	ΛΩ = 0		- 20		– 100	- 20		– 100	mA.
laa	'LS594	Voc = MAY		-		34	50		34	50	^
ICCH	'LS599	V _{CC} = MAX,	uto aroundo-l			30	45		30	45	mA
laa.	'LS594	1 '	All possible inputs grounded,			42	65		42	65	
ICCL	'LS599	All outputs ope	All outputs open			38	55		38	55	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

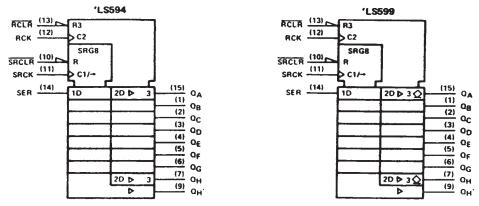
switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$, (see note 3)

DADAMETED	FROM	TO (OUTPUT)	TEST CONDITIONS		'LS594			'LS599			
PARAMETER	(INPUT)				MIN	TYP	MAX	MIN	TYP	MAX	UNIT
tPLH	SRCKT	Q _H ′	R _L = 1 kΩ,	C _L = 30 pF		12	18		12	18	ns
t _{PHL}						15	23		17	25	ns
tPLH	RCKt	RCKf QA thru QH	R _L = 667 Ω,	C _L = 45 pF		12	18		28	42	ns
tPHL						20	30		24	35	ns
tPHL	SRCLR↓	QH'	$R_L = 1 k\Omega$,	C _L = 30 pF		22	33		24	35	ns
t _{PHL}	RCLR	Q _A thru Q _H	$R_L = 667 \Omega$,	C _L = 45 pF		38	57		40	60	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

 $[\]ddagger$ All typical values are at V_{CC} = 5 V, T_A = 25°C. \$ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

logic symbols[†]



[†]These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for J, N, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)		 7 V
Input voltage		 7 V
Off-state output voltage		 5.5 V
Operating free-air temperature range:	SN54LS594, SN54LS599	 - 55°C to 125°C
	SN74LS594, SN74LS599	 0°C to 70°C
Storage temperature range	· · · · · · · · · · · · · · · · · · ·	 – 65°C to 150°C

NOTE 1: Voltage values are with respect to the network ground terminal.

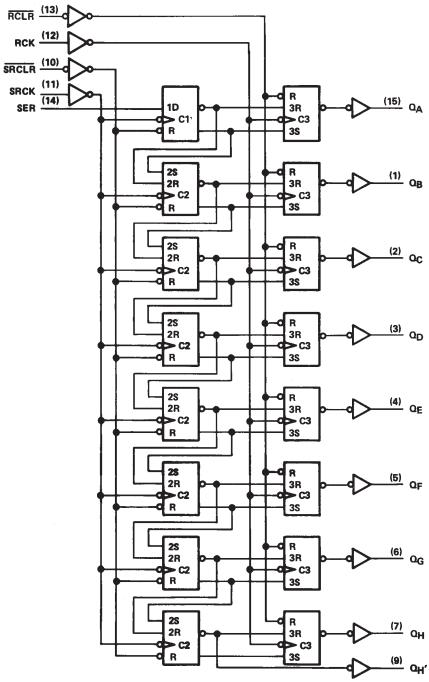
recommended operating conditions

			SN54LS'		SN74LS'			UNIT	
			MIN	NOM	MAX	MIN	NOM	MAX	CIVII
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High-level input voltage		2			2			V
VIL	Low-level input voltage				0.7			0.8	٧
Voн	High-level output voltage	Q _A thru Q _H , 'LS599 only			5.5			5.5	V
la	High-level output current	QH'	1		– 1			-1	mΑ
ЮН		QA thru QH, 'LS594 only			- 1			- 2.6	mA
la.	Low-level output current	QH'			8			16	mA
OL		Q			12			24	
fSRCK	Shift clock frequency		0		20	0		20	MHz
fRCK	Register clock frequency		0		25	0		25	MHz
tw(SRCK)	Duration of shift clock pulse		25			25			ns
tw(RCK)	Duration of register clock pulse		20			20			ns
tw(SRCLR)	Duration of shift clear pulse, low level		20			20			ns
tw(RCLR)	Duration of register clear pulse, low level		35			35			ns
	Setup time	SRCLR inactive before SRCK1	20			20			
		SER before SRCK1	20			20			ns
t _{su}		SRCK1 before RCK1 (see Note 2)	40			40			
		SRCLR low before RCK1	40			40			
		RCLR high before RCK1	20			20			
th	Hold time	SER after SRCK1	0	_		0			ns
TA	Operating free-air temperature		- 55		125	0		70	°C

NOTE 2: This setup time ensures the register will see stable data from the shift-register outputs. The clocks may be connected together, in which case the storage register state will be one clock pulse behind the shift register.



logic diagram (positive logic)



Pin numbers shown are for J, N, and W packages.

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